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Ceramic plates and Ceramic ring for polishing

SUNTEK ceramic plates are used for CMP polishing, with various outer diameter and thickness. It has perfect performance during silicon and sapphire back grinding and thinning.



Character:

CMP polish for 3,4,5,6 inch wafer.
High flatness and parallelism,
Perfect compact and uniform microstructure

SUNTEK ceramic rings are used for grinder dressing and to keep flat, with good dewatering and super high precision.

It is a necessary during silicon and sapphire back grinding and thinning.



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